

General Description

The MDHT4N20Y uses advanced Magnachip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality.

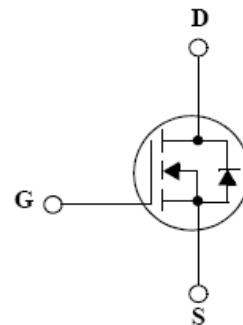
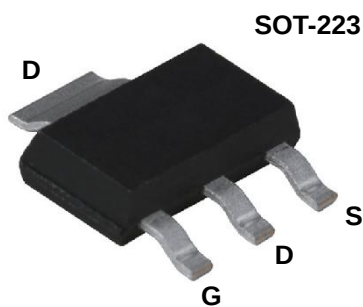
MDHT4N20Y is suitable device for LED TV and general purpose applications.

Features

- $V_{DS} = 200V$
 - $I_D = 0.85A$
 - $R_{DS(ON)} \leq 1.35\Omega$
- @ $V_{GS} = 10V$
@ $V_{GS} = 10V$

Applications

- Power Supply
- PFC
- LED TV



Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	200	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current	$T_C = 25^\circ C$	I_D	0.85	A
	$T_C = 100^\circ C$		0.54	A
Pulsed Drain Current ⁽¹⁾		I_{DM}	3.4	A
Power Dissipation	$T_C = 25^\circ C$	P_D	2.1	W
	Derate above 25 °C		0.017	W/°C
Peak Diode Recovery dv/dt ⁽³⁾		Dv/dt	5.5	V/ns
Repetitive Pulse Avalanche Energy ⁽⁴⁾		E_{AR}	0.21	mJ
Avalanche current ⁽¹⁾		I_{AR}	0.85	A
Single Pulse Avalanche Energy ⁽⁴⁾		E_{AS}	52	mJ
Junction and Storage Temperature Range		T_J, T_{stg}	-55~150	°C

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient *	$R_{\theta JA}$	60	°C/W

* When mounted on the minimum pad size recommended (PCM Mount)

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDHT4N20YURH	-55~150°C	SOT-223	Reel and Tape	Halogen Free

Electrical Characteristics (Ta =25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V	200	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.0	-	2.0	
Drain Cut-Off Current	I _{DSS}	V _{DS} = 200V, V _{GS} = 0V	-	-	1	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V	-	-	100	nA
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 0.425A	-	1.1	1.35	Ω
Forward Transconductance	g _{fs}	V _{DS} = 30V, I _D = 0.425A	-	1.3	-	S
Dynamic Characteristics						
Total Gate Charge	Q _g	V _{DS} = 160V, I _D = 3.8A, V _{GS} = 5V	-	3.2	-	nC
Gate-Source Charge	Q _{gs}		-	0.64	-	
Gate-Drain Charge	Q _{gd}		-	1.6	-	
Input Capacitance	C _{iss}	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	-	148	-	pF
Reverse Transfer Capacitance	C _{rss}		-	11.3	-	
Output Capacitance	C _{oss}		-	42.7	-	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 5V, V _{DS} = 100V, I _D = 3.8A, R _G = 25Ω	-	6	-	ns
Rise Time	t _r		-	38	-	
Turn-Off Delay Time	t _{d(off)}		-	11	-	
Fall Time	t _f		-	13	-	
Drain-Source Body Diode Characteristics						
Maximum Continuous Drain to Source Diode Forward Current	I _S		-	0.85	-	A
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 0.85A, V _{GS} = 0V	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 3.8A, dI/dt = 100A/μs ⁽³⁾	-	90	-	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	0.24	-	μC

Note :

1. Pulse width is based on $R_{\theta JC}$ & $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ C$.
3. $I_{SD} \leq 3.8A$, $di/dt \leq 300A/\mu s$, $V_{DD} \leq BV_{DSS}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$
4. $L = 108mH$, $I_{AS} = 0.85A$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$

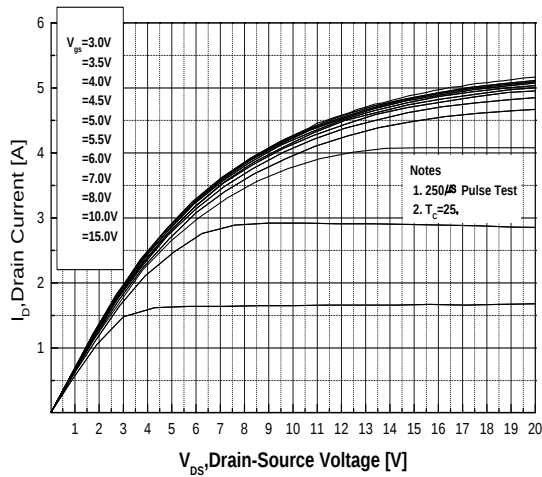


Fig.1 On-Region Characteristics

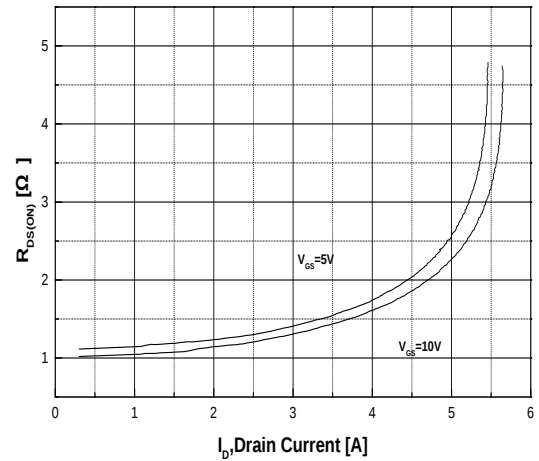


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

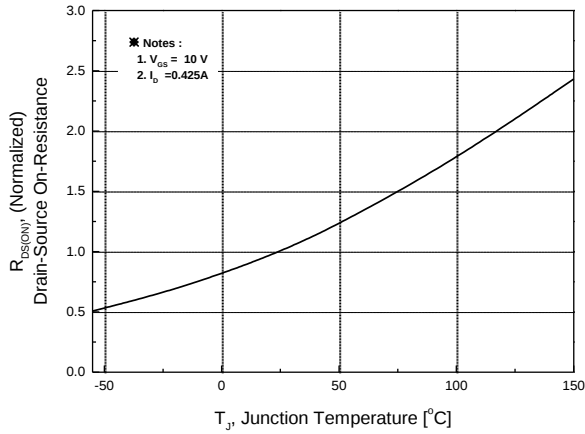


Fig.3 On-Resistance Variation with Temperature

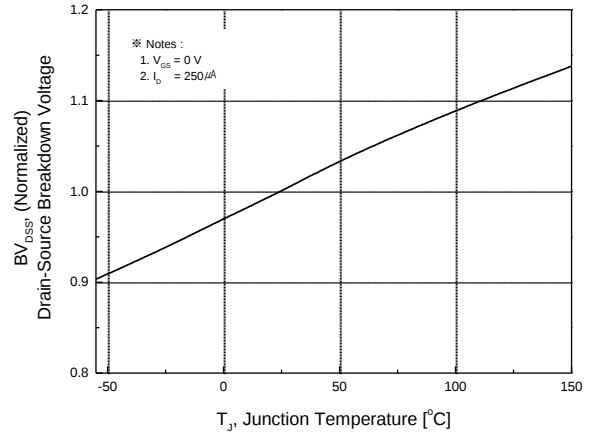


Fig.4 Breakdown Voltage Variation vs. Temperature

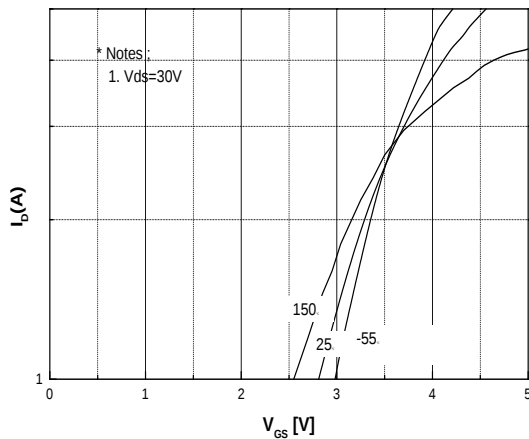


Fig.5 Transfer Characteristics

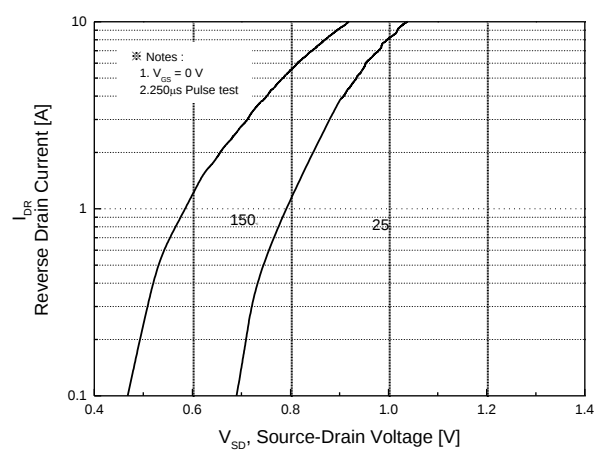


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

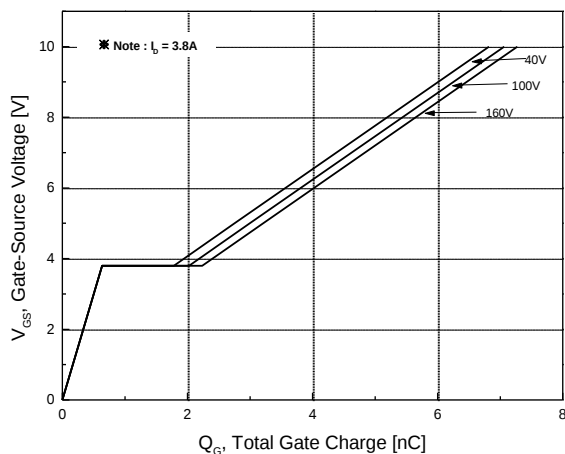


Fig.7 Gate Charge Characteristics

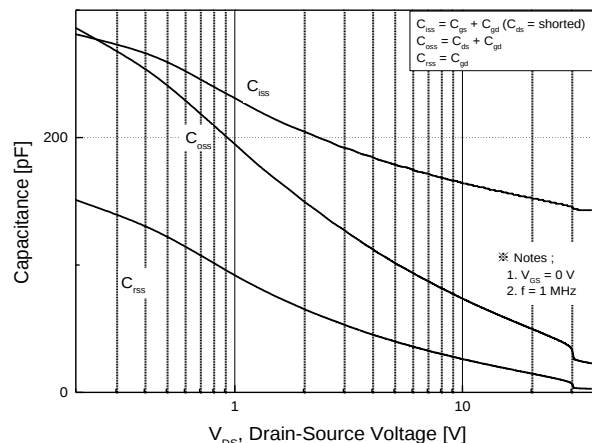


Fig.8 Capacitance Characteristics

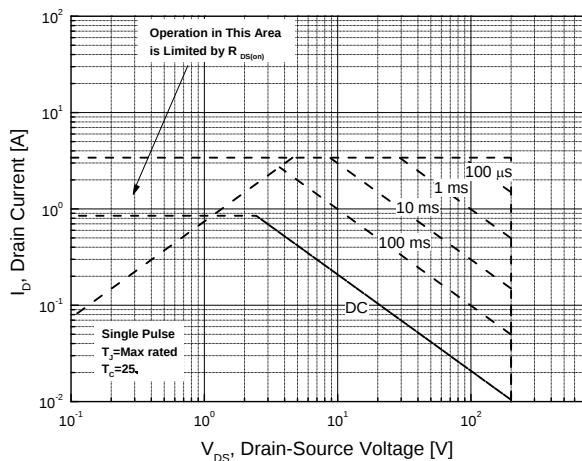


Fig.9 Maximum Safe Operating Area

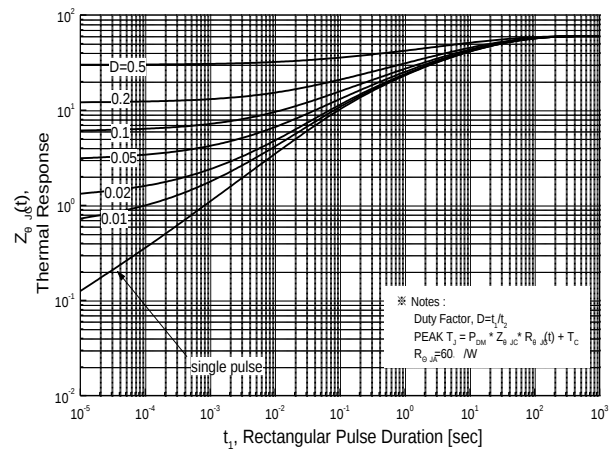


Fig.10 Transient Thermal Response Curve

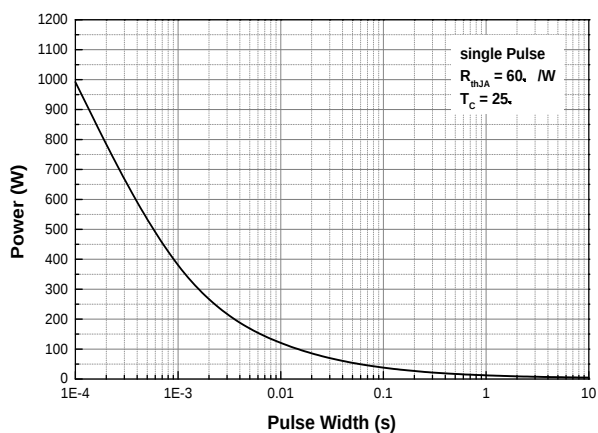


Fig.11 Single Pulse Maximum Power Dissipation

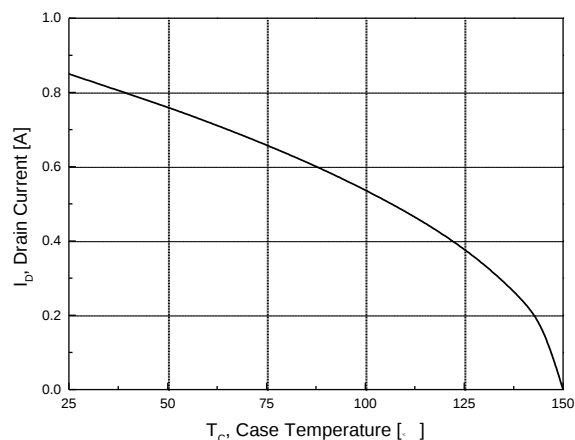
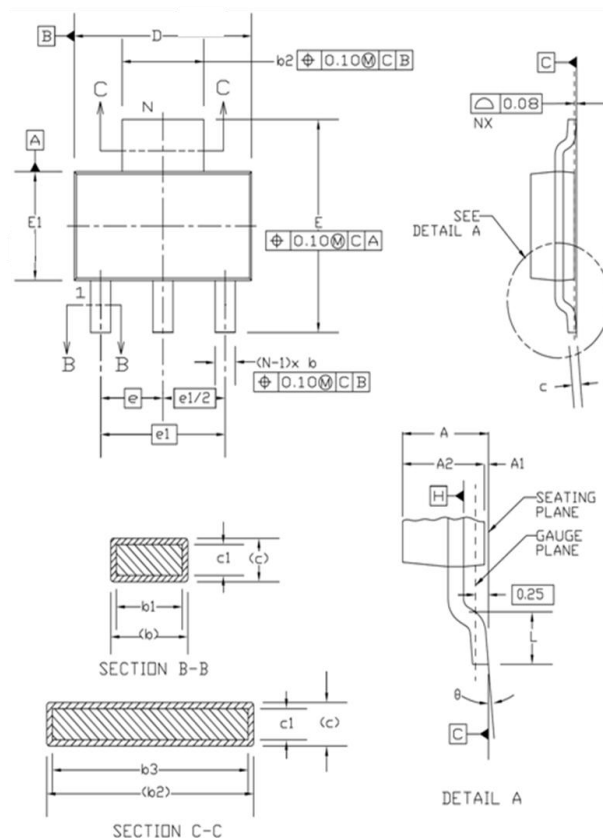


Fig.12 Maximum Drain Current vs. Case Temperature

Physical Dimension

SOT-223

Dimensions are in millimeters, unless otherwise specified



Symbol	Min	Nom	Max
A	-	-	1.80
A1	0.00	-	0.10
A2	1.50	-	1.70
b	0.60	-	0.84
b1	0.60	-	0.79
b2	2.90	-	3.10
b3	2.84	-	3.05
c	0.23	-	0.35
c1	0.23	-	0.33
D	6.20	-	6.70
E	6.70	-	7.30
E1	3.30	-	3.70
e	2.30 BASIC		
e1	4.60 BASIC		
L	0.75	-	-
θ	0°	-	10°

DISCLAIMER:

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